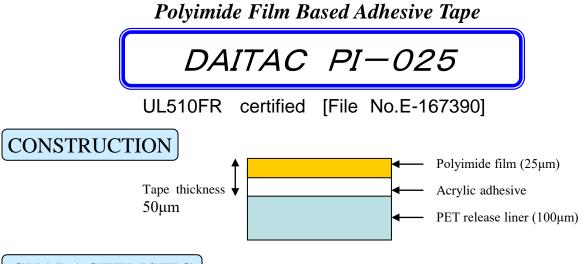
# **TECHNICAL INFORMATION**





## CHARACTERISTIC

- •Excellent heat resistance (150°C heat resistance).
- •Excellent insulating.
- Release film provide excellent workability and improves processing performance.
- The six hazardous materials restricted by the RoHS directive are not compounded

#### APPLICATION

• Insulating purpose for electrical and electronics devices.

#### PROPERTY

		Unit	PI-025
Peel strength	SUS	N / 25mm	9.8
at 180° angle	Copper		6. 0
	Aluminum		5.0
	ABS		9.0
	Polyimide		9.0
Holdig power(150°C,1kg)		mm/h	2 >
Surface resistance		Ω	> 10 <sup>14</sup>
Volume resistance		Ω・m	> 10 <sup>14</sup>
Dielectric breakdown voltage		k V	7

STANDARD SIZE

### 980 mm in max width / 50 m in length

**DIC** Corporation

Composite Material Div.

http://www.dic-global.com/en/

Items mentioned in this information are for customers ' reference and limited to certain examples although they are based on the most reliable data obtained by our company. It is hoped that customers make the best use of these products after careful examination. Concerning to use and processing the products on this documents, it is not guaranteed a industrial ownerships of a third party. All recipes and processes should be modified, if necessary to conform with particular application.